TOSHIBA INFRARED LED GaAs INFRARED EMITTER

## TLN104, TLN104(LB)

INFRARED LED FOR PHOTO SENSOR

TAPE, CARD READERS
HANDY TERMINAL
AUDIO, VIDEO EQUIPMENT
OPTO-ELECTRONIC SWITCH

Micro-package (epoxy resin package)

Double end type : TLN104

DIP type : TLN104 (LB)

• Mountable at a 2.5mm pitch

• Large radiant power : Po=3mW (TYP.)

• Excellent linearity of radiant power and modulation by pulse operation and high frequency is possible.

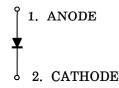
• Half value angle :  $\theta_{\frac{1}{2}} = \pm 20^{\circ}$  (TYP.)

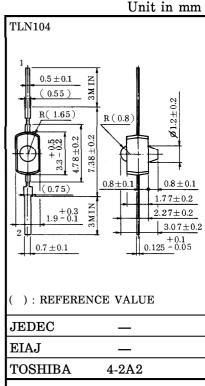
## MAXIMUM RATINGS (Ta = 25°C)

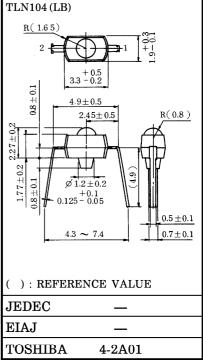
| CHARACTERISTIC                      | SYMBOL RATING                              |         | UNIT  |  |
|-------------------------------------|--|---------|-------|--|
| Forward Current                     | $I_{\mathbf{F}}$                           | 40      | mA    |  |
| Forward Current Derating (Ta>25°C)  | $\Delta I_{\mathbf{F}}/^{\circ}\mathbf{C}$ | -0.53   | mA/°C |  |
| Pulse Forward Current               | I <sub>FP</sub> (Note 1)                   | 400     | mA    |  |
| Reverse Voltage                     | $V_{\mathbf{R}}$                           | 5       | V     |  |
| Operating Temperature Range         | $T_{ m opr}$                               | -25~85  | °C    |  |
| Storage Temperature Range           | $\mathrm{T_{stg}}$                         | -30~100 | °C    |  |
| Soldering Temperature<br>Range (3s) | $T_{\mathrm{sol}}$                         | 260     | °C    |  |

Note 1. Pulse Width≤100μs, Repetitive Frequency=100Hz

PIN CONNECTION







Weight: 0.02g (TYP.)

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TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

| CHARACTERISTIC           | SYMBOL                 | TEST CONDITION                  | MIN. | TYP. | MAX. | UNIT    |
|--------------------------|------------------------|---------------------------------|------|------|------|---------|
| Forward Voltage          | $ m V_{ m F}$          | $I_{ m F} = 10 { m mA}$         | _    | 1.13 | 1.35 | V       |
| Reverse Current          | $_{ m I_R}$            | $V_R = 5V$                      | _    | _    | 10   | $\mu$ A |
| Rediant Power (Note 2)   | PO                     | $I_{ m F}\!=\!20{ m mA}$        | 1.5  | 3    | _    | mW      |
| Capacitance              | $\mathrm{c_{T}}$       | $V_R = 0$ , $f = 1MHz$          | _    | 50   | _    | рF      |
| Peak Emission Wavelength | $\lambda_{\mathbf{P}}$ | $I_{	extbf{F}} = 20 	ext{mA}$   | _    | 940  | _    | nm      |
| Spectral Line Half Width | Δλ                     | $I_{ m F}\!=\!20{ m mA}$        | _    | 50   | _    | nm      |
| Half Value Angle         | $\theta \frac{1}{2}$   | $I_{\mathbf{F}} = 20 \text{mA}$ | _    | ±20  | _    | ٥       |

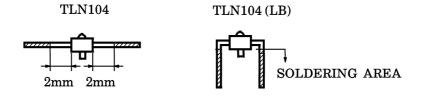
## OPTO-ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Po Classification B: 2.5~6.0mW Note 2.

## **PRECAUTION**

Please be careful of the followings.

- If the lead is formed, the lead should be formed at a distance of 0.8mm from the body of the device.
  - Soldering shall be performed after lead forming. However, in case of TLN104(LB), no lead forming shall be performed.
- Soldering shall be performed within the range shown below.



AREA 2mm AWAY FROM THE PACKAGE ENDS

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Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

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